ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC. Bannockl	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	bstances v all lower	within the manufactu level materials for w	rer listed i which the r	tem. Note: i nanufacture	f the item is an as r has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials an					ials and M	fg Informat	ion		
Supplier Information														
Company name* Comp			Company unique ID			Unique ID Authority				Respon	Response Date*			
nsemi									2025-05-11					
ntact Name Title - Contact]	Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product Enviro			ro Compliance		NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			ntative		Phone - Representative*			Email - Representative*						
Product-Env-Stewards Product Enviro			iro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	Version	М	Ianufacturing Site		Weight*	UOM	Unit Type	
	FAN738	FAN7380MX-OP Half bridge		gate driver		2025-05-11		T	TH2		83.484	mg	Each	
Ianufacturing Proccess Informa	ation							·						
Terminal Plating / Grid Array M	laterial 7	Ferminal Base	Alloy J-STD-020 MSL Rati		L Rating	Peak Proce	ess Body Temperature Max Time at Pea		Tempera	ture Numl	per of Reflow Cyc	les		
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	secor	nds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.16	mg	Supplier	Silicon (Si)	7440-21-3		2.16	mg
Die Attach	1.144	mg		Epoxy resin	proprietary data		0.1487	mg
			Supplier	Silver (Ag)	7440-22-4		0.4004	mg
			Supplier	Acrylic resins	Proprietary Data		0.1945	mg
			Supplier	Aluminum (Al)	7429-90-5		0.4004	mg
Lead Frame	31.136	mg	Supplier	Silver (Ag)	7440-22-4		0.6227	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0374	mg
			Supplier	Iron (Fe)	7439-89-6		0.7317	mg
			Supplier	Copper (Cu)	7440-50-8		29.7349	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0093	mg
Mold Compound-Black	45.29	mg	Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'- tetramethylbiphenyl	85954-11-6		2.0381	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2264	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		41.6668	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.3587	mg
lating	3.44	mg	Supplier	Tin (Sn)	7440-31-5		3.44	mg
Wire Bond	0.314	mg	Supplier	Palladium (Pd)	7440-05-3		0.006	mg
			Supplier	Gold (Au)	7440-57-5		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.3077	mg